

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IPB240N03S4L-R8	**Issued**	27. April 2022
MA#	MA005741014		
Package	PG-TO263-7-3	**Weight***	1533.12 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	10.245	0.67	0.67	6682	6682
leadframe	inorganic material	phosphorus	7723-14-0	0.241	0.02		157	
	non noble metal	iron	7439-89-6	0.803	0.05		524	
	non noble metal	copper	7440-50-8	801.714	52.29	52.36	522930	523611
wire	non noble metal	aluminium	7429-90-5	23.923	1.56	1.56	15604	15604
encapsulation	inorganic material	zincoxide	1314-13-2	5.705	0.37		3721	
	miscellaneous	miscellaneous	-	22.820	1.49		14885	
	plastics	epoxy resin	-	85.576	5.58		55818	
	inorganic material	silicondioxide	60676-86-0	456.406	29.77	37.21	297698	372122
leadfinish	non noble metal	tin	7440-31-5	12.317	0.80	0.80	8034	8034
plating	inorganic material	phosphorus	7723-14-0	0.001			1	
	non noble metal	nickel	7440-02-0	0.269	0.02	0.02	176	177
solder	non noble metal	tin	7440-31-5	0.135	0.01		88	
	noble metal	silver	7440-22-4	0.169	0.01		110	
	non noble metal	lead	7439-92-1	6.447	0.42	0.44	4205	4403
heatspreader	inorganic material	phosphorus	7723-14-0	0.032			21	
	non noble metal	iron	7439-89-6	0.106	0.01		69	
	non noble metal	copper	7440-50-8	106.210	6.93	6.94	69277	69367
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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